

To: Facsimile Number: 703-872-9306

From:

Texas Instruments Incorporated
Facsimile: 972-917-4418

RECEIVED
CENTRAL FAX CENTER Total Pages Sent 2
OCT 25 2004

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

In re the Application of

Applicant Andrew Marshall

Docket Number: TI-31484

Serial No.: 10/007,332

Art Unit: 2815

Filed: 11/08/01

Examiner: Matthew E. Warren

For: Thermal Coupling of Matched SOI Device Bodies

CERTIFICATION OF FACSIMILE TRANSMISSION

I hereby certify that the following papers are being transmitted by facsimile to the U.S. Patent and Trademark Office on the date shown below:

Karen Vertz
Karen Vertz

10-25-04
Date

FACSIMILE COVER SHEET

<input checked="" type="checkbox"/> FACSIMILE COVER SHEET	<input type="checkbox"/> AMENDMENT (# Pages)
<input type="checkbox"/> NEW APPLICATION	<input type="checkbox"/> EOT
<input type="checkbox"/> DECLARATION	<input checked="" type="checkbox"/> NOTICE OF APPEAL
<input type="checkbox"/> ASSIGNMENT	<input type="checkbox"/> APPEAL (# Pages)
<input type="checkbox"/> FORMAL DRAWINGS	<input type="checkbox"/> ISSUE FEE & PUBLICATION FEE (1 Page)
<input type="checkbox"/> INFORMAL DRAWINGS	<input type="checkbox"/> REPLY BRIEF (IN TRIPLICATE) (# Pages)
<input type="checkbox"/> CONTINUATION APPN	<input type="checkbox"/> ELECTION
<input type="checkbox"/> DIVISIONAL APPN	
NAME OF INVENTOR(S): Andrew Marshall	
TITLE OF INVENTION: Thermal Coupling of Matched SOI Device Bodies	
RECEIPT DATE & SERIAL NO.: Serial No.: 10/007,332 Filing Date: 11/08/01	
TITLE NO.: TI-31484	DEPOSIT ACCT. NO.: 20-0668
FAXED: 10-25-04 DUE: 10-26-04 ATTY/SECY: RAK/qv	

This facsimile is intended only for the use of the address named and contains legally privileged and/or confidential information. If you are not the intended recipient of this telecopy, you are hereby notified that any dissemination, distribution, copying or use of this communication is strictly prohibited. Applicable privileges are not waived by virtue of the document having been transmitted by Facsimile. Any misdirected facsimiles should be returned to the sender by mail at the address indicated on this cover sheet.

Texas Instruments Incorporated
PO Box 855474, M/S 3999
Dallas, TX 75285-5474

RECEIVED
CENTRAL FAX CENTER

OCT 25 2004

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

In re Application of

Andrew Marshall

TI-31484

Examiner: Matthew E. Warren

Art Unit 2815

Serial No.: 10/007,332

Filed: 11/08/01

For: Thermal Coupling of Matched SOI Device Bodies

NOTICE OF APPEAL FROM THE PRIMARY EXAMINER TO THE BOARD OF APPEALS

CERTIFICATION OF FACSIMILE TRANSMISSION	
I hereby certify that the above correspondence is being transmitted by facsimile to the U.S. Patent and Trademark Office at 703-872-9306 on the date shown below:	
<u>Karen Vertz</u> Karen Vertz	<u>10-25-04</u> Date

Commissioner for Patents
P.O. Box 1450
Alexandria, VA 22313-1450

Sir:

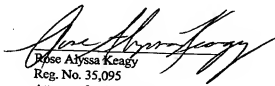
Applicant hereby appeals claims 6-13 and 15-19 to the Board of Appeals from the decision dated July 26, 2004 of the Primary Examiner finally rejecting claims 6-13 and 15-19.

The item(s) checked below are appropriate:

1. ☐ An extension of time to respond to the final rejection
☐ was granted on ____
☐ is requested for ____ month(s).
2. ☒ A timely response to the final rejection has been filed, as provided in 841 O.G. 1411.
3. ☒ Fee \$340.00:
☐ Not required (Fee paid in prior appeal)
☒ The Commissioner of Patents is hereby authorized to charge any fees which may be required, or credit any overpayment to Deposit Account No. 20-0668 of Texas Instruments Incorporated.

Signature [Rule 191(b)]:

Post Office Address (to which correspondence is to be sent)
Texas Instruments Incorporated
P.O. Box 655474, MS 3999
Dallas, TX 75265
(972) 917-4167


Rose Alyssa Keagy
Reg. No. 35,095
Attorney for Appellants